

April 2013

MOC211M, MOC212M, MOC213M Small Ouline Optocouplers Transistor Output

Features

- UL Recognized (File #E90700, Volume 2)
- VDE Recognized (File #136616) (add option 'V' for VDE approval, e.g., MOC211VM)
- Convenient Plastic SOIC-8 Surface Mountable Package Style
- Standard SOIC-8 Footprint, with 0.050" Lead Spacing
- High Input-Output Isolation of 2500 V_{AC(rms)} Guaranteed
- Minimum BV_{CEO} of 30V Guaranteed

Applications

- General Purpose Switching Circuits
- Interfacing and Coupling Systems of Different Potentials and Impedances
- Regulation Feedback Circuits
- Monitor and Detection Circuits

Description

These devices consist of a gallium arsenide infrared emitting diode optically coupled to a monolithic silicon phototransistor detector, in a surface mountable, small outline, plastic package. They are ideally suited for high density applications, and eliminate the need for throughthe-board mounting.

Schematic

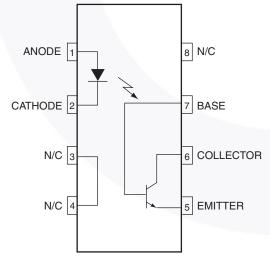


Figure 1. Schematic

Package Outline

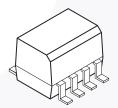


Figure 2. Package Outline

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A = 25^{\circ}C$ unless otherwise specified.

Symbol	Rating	Value	Unit	
Emitter				
I _F	Forward Current – Continuous	60	mA	
I _F (pk)	Forward Current – Peak (PW = 100 µs, 120 pps)	1.0	Α	
V _R	Reverse Voltage	6.0	V	
P _D	LED Power Dissipation @ T _A = 25°C Derate above 25°C	90 0.8	mW mW/°C	
Detector				
V _{CEO}	Collector-Emitter Voltage	30	V	
V _{ECO}	Emitter-Collector Voltage	7.0	V	
V _{CBO}	Collector-Base Voltage	70	V	
I _C	Collector Current-Continuous	150	mA	
P_{D}	Detector Power Dissipation @ T _A = 25°C Derate above 25°C	150 1.76	mW mW/°C	
Total Device				
V_{ISO}	Input-Output Isolation Voltage $(f = 60 \text{ Hz}, t = 1 \text{ minute})^{(1)(2)(3)}$	2500	Vac(rms)	
P_{D}	Total Device Power Dissipation @ T _A = 25°C Derate above 25°C	250 2.94	mW mW/°C	
T _A	Ambient Operating Temperature Range	-40 to +100	°C	
T _{stg}	Storage Temperature Range	-40 to +150	°C	
TL	Lead Soldering Temperature (1/16" from case, 10 second duration)	260	°C	

Notes:

- 1. Isolation Surge Voltage, $V_{\mbox{\scriptsize ISO}}$, is an internal device dielectric breakdown rating.
- 2. For this test, Pins 1 and 2 are common and Pins 5, 6 and 7 are common.
- 3. V_{ISO} rating of 2500 $V_{AC(rms)}$ for t = 1 minute is equivalent to a rating of 3,000 $V_{AC(rms)}$ for t = 1 second.

Electrical Characteristics

 $T_A = 25$ °C unless otherwise specified.

Symbol	Parameter	Test Conditions	Min.	Тур.*	Max.	Unit
Emitter				I		1
V _F	Input Forward Voltage	I _F = 10 mA		1.15	1.5	V
I _R	Reverse Leakage Current	V _R = 6.0 V		0.001	100	μA
C _{IN}	Input Capacitance			18		pF
Detector			1			•
I _{CEO1}	Collector-Emitter Dark Current	V _{CE} = 10 V, T _A = 25°C V _{CE} = 10 V, T _A = 100°C		1.0 1.0	50	nΑ μΑ
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 100 μA	30	100		V
BV _{ECO}	Emitter-Collector Breakdown Voltage	I _E = 100 μA	7.0	10		V
C _{CE}	Collector-Emitter Capacitance	f = 1.0 MHz, V _{CE} = 0		7.0		pF
Coupled			•			
CTR	Collector-Output Current ⁽⁴⁾ MOC211M MOC212M MOC213M	I _F = 10 mA, V _{CE} = 10 V	20 50 100			%
V _{ISO}	Isolation Surge Voltage ⁽¹⁾⁽²⁾⁽³⁾	f = 60 Hz AC Peak, t = 1 minute	2500			Vac(rms)
R _{ISO}	Isolation Resistance ⁽²⁾	V = 500 V	10 ¹¹			Ω
V _{CE (sat)}	Collector-Emitter Saturation Voltage	I _C = 2.0 mA, I _F = 10 mA			0.4	V
C _{ISO}	Isolation Capacitance ⁽²⁾	V = 0 V, f = 1 MHz		0.2		pF
t _{on}	Turn-On Time	I_C = 2.0 mA, V_{CC} = 10 V, R_L = 100 Ω (Fig. 12)		7.5		μs
t _{off}	Turn-Off Time	I_C = 2.0 mA, V_{CC} = 10 V, R_L = 100 Ω (Fig. 12)		5.7		μs
t _r	Rise Time	I_C = 2.0 mA, V_{CC} = 10 V, R_L = 100 Ω (Fig. 12)		3.2		μs
t _f	Fall Time	$I_{\rm C}$ = 2.0 mA, $V_{\rm CC}$ = 10 V, $R_{\rm L}$ = 100 Ω (Fig. 12)		4.7		μs

^{*}Typical values at T_A = 25°C

Notes:

- 1. Isolation Surge Voltage, V_{ISO} , is an internal device dielectric breakdown rating.
- 2. For this test, Pins 1 and 2 are common and Pins 5, 6 and 7 are common.
- 3. V_{ISO} rating of 2500 $V_{AC(rms)}$ for t = 1 minute is equivalent to a rating of 3,000 $V_{AC(rms)}$ for t = 1 second.
- 4. Current Transfer Ratio (CTR) = $I_C / I_F x 100 \%$.

Typical Performance Curves

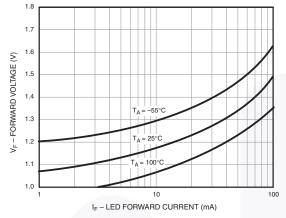
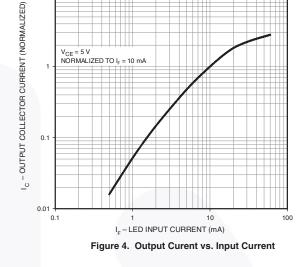


Figure 3. LED Forward Voltage vs. Forward Current



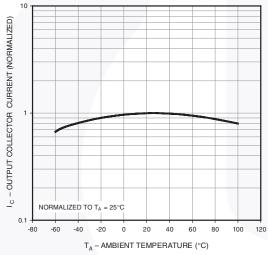


Figure 5. Output Current vs. Ambient Temperature

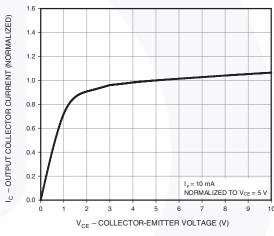


Figure 6. Output Current vs. Collector-Emitter Voltage

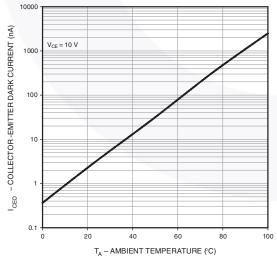


Figure 7. Dark Current vs. Ambient Temperature

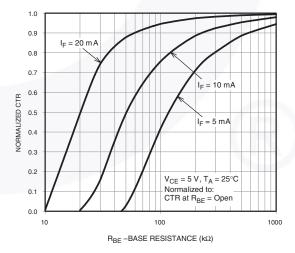


Figure 8. CTR vs. RBE (Unsaturated)

Typical Performance Curves (Continued)

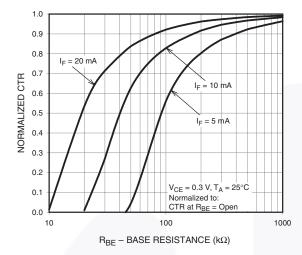


Figure 9. CTR vs. RBE (Saturated)

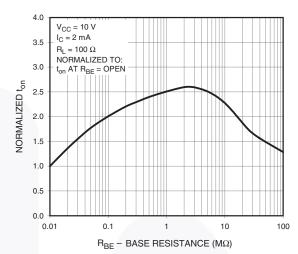


Figure 10. Normalized ton vs. RBE

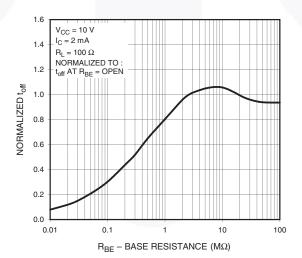


Figure 11. Normalized toff vs. RBE

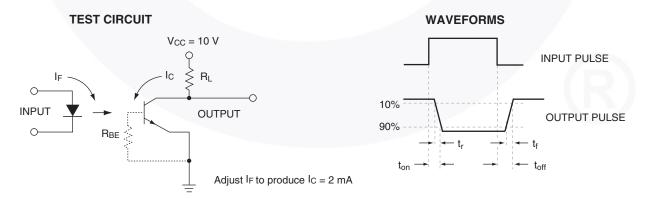
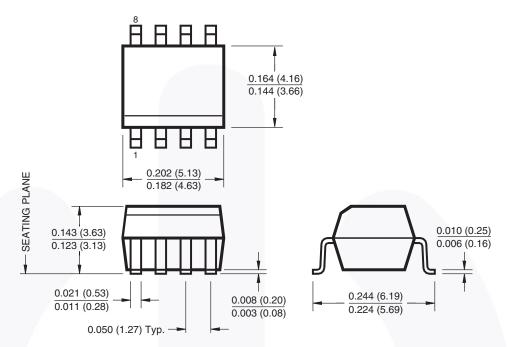


Figure 12. Switching Time Test Circuit and Waveforms

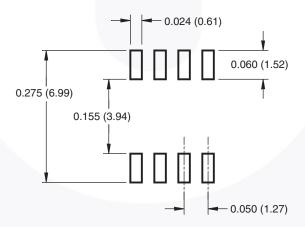
Package Dimensions

8-pin SOIC Surface Mount



Lead Coplanarity: 0.004 (0.10) MAX

Recommended Pad Layout



Dimensions in inches (mm).

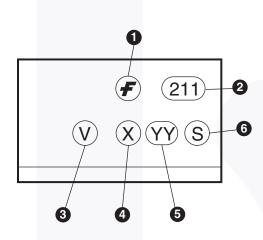
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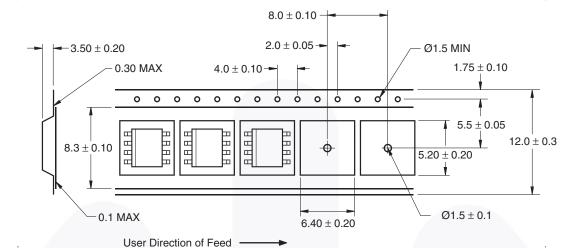
Option	Order Entry Identifier	Description	
V	V	VDE 0884	
R2	R2	Tape and Reel (2500 units per reel)	
R2V	R2V	VDE 0884, Tape and Reel (2500 units per reel)	

Marking Information



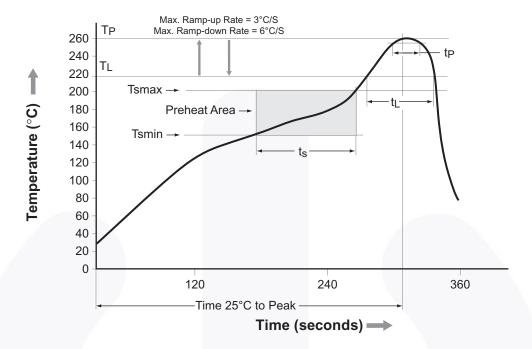
Defini	tions	
1	Fairchild logo	
2	Device number	
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)	
4	One digit year code, e.g., '8'	
5	Two digit work week ranging from '01' to '53'	
6	Assembly package code	

Carrier Tape Specifications



Dimensions in mm

Reflow Profile



Profile Freature	Pb-Free Assembly Profile
Temperature Minimum (Tsmin)	150°C
Temperature Maximum (Tsmax)	200°C
Time (t _S) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second maximum
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60-150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second maximum
Time 25°C to Peak Temperature	8 minutes maximum



(b)

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